

SPI 2019

Chambéry, France
18-21 June 2019

23RD IEEE WORKSHOP ON SIGNAL AND POWER INTEGRITY

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SPONSORSHIP INFORMATION

OVERVIEW

Over the past two decades, the IEEE Workshop on Signal and Power Integrity (SPI) has evolved into a forum of exchange on the latest research and developments on design, characterization, modeling, simulation and testing for signal and power integrity at chip, package, board and system level. The workshop brings together developers and researchers from industry and academia in order to encourage cooperation. SPI is also hosting an **Industry Forum**, a special session, featuring both contributed and invited talks, mainly focused on problems rather than solutions. The explicit goal is to foster the discussion between industry, academia, and tool vendors, so that the three communities can cooperate in the future and focus on the most relevant problems.

SPONSORING OPPORTUNITIES

Around a hundred participants from more than fifteen countries are expected at SPI 2019 in the French Alps in the charming town of Chambéry making the conference the ideal venue to provide your institution with an exceptional level of international exposure for your products and services, and to significantly enhance your visibility and reputation with regards to signal and power integrity. The workshop will be hosted by the elegant conference center "Le Manège". By sponsoring SPI 2019, you will be able to showcase and promote your products to conference participants from both companies and research institutes. Your logo and company information will be included on all material promoting the conference on the web and on social media.

Several sponsorship opportunities with attractive benefits are available (Platinum, Gold, and Silver). Each level of sponsorship provides a different level of company exposure and marketing opportunities, including:

- Booth space during the conference
- Complimentary full registrations for the conference
- Possibility to include brochures and gadgets in conference bags
- Company logo on conference web site and conference materials
- Dedicated space in the front matter of conference proceedings
- Formal acknowledgment in final program, opening, and closing ceremonies



Customized sponsorship packages are also available on request.



<https://spi2019.sciencesconf.org>



SPONSORSHIP PACKAGES

Platinum sponsorship (cost: 5000€ + VAT, limited to 2 exclusive sponsors) includes:

- Prominent exhibition booth space during the conference
- Up to three complimentary full registrations for the conference
- Possibility to include brochures and gadgets in conference bags
- Prominent visibility on conference web site and all conference material
- Two full pages in the conference proceedings (front matter)
- Formal acknowledgment in final program, opening, and closing ceremonies

Gold sponsorship (cost: 3000€ + VAT) includes:

- Exhibition booth space during the conference
- Up to two complimentary full registrations for the conference
- Possibility to include brochures and gadgets in conference bags
- Visibility on conference web site and all conference material
- One full page in the conference proceedings (front matter)
- Formal acknowledgment in final program, opening, and closing ceremonies

Silver sponsorship (cost: 2000€ + VAT) includes:

- Exhibition booth space during the conference
- One complimentary full registration for the conference
- Company logo displayed on conference web site and all conference material
- One half page in the conference proceedings (front matter)
- Acknowledgment as Silver sponsor in final program

Custom sponsorship packages (to be negotiated) may include as additional/separate items:

- Social event and gala dinner sponsorship
- Coffee break sponsorship
- Logo-only displayed on conference web site
- Possibility to supply badge lanyards
- Possibility to supply conference bags
- Additional full conference registrations



CONTACT INFORMATION

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